

MOSFET

OptiMOS[™] 5 Power-Transistor, 150 V

Features

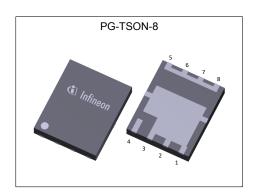
- N-channel, normal level
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliantHalogen-free according to IEC61249-2-21
- Very low reverse recovery charge (Q_{rr})

Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Kev Performance Parameters**

10.010 1 110 1 110 1110 1110 1110 110 11								
Parameter	Value	Unit						
V _{DS}	150	V						
$R_{DS(on),max}$	6.32	mΩ						
I_{D}	148	Α						
Q _{oss}	136	nC						
Q _G	48	nC						











Type / Ordering Code	Package	Marking	Related Links
IQD063N15NM5	PG-TSON-8	06315N5	-

OptiMOS[™] 5 Power-Transistor, 150 V



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Damamatan	Symbol	Values			ļ., .,	
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	148 94 89 14.1	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	592	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	300	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	278 2.5	W	T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
rarameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	0.45	°C/W	-	
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R _{thJA}	-	-	50	°C/W	-	

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for source

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

D	0	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	3.0	3.8	4.6	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 159 \ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	5.1 5.6	6.32 7.08	mΩ	V _{GS} =10 V, I _D =50 A V _{GS} =8 V, I _D =25 A
Gate resistance	R _G	-	0.89	-	Ω	-
Transconductance	g fs	45	89	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 50 A$

Table 5 **Dynamic characteristics**

Parameter	Symbol	Values			11:4	Nata (Tant Oan dition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	Ciss	-	3600	4700	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	900	1200	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	21	37	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	11	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	5	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	t _{d(off)}	-	14	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	4	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Symbol	Values			l lmi4	Note / Test Condition
Parameter		Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	20	-	nC	V _{DD} =75 V, I _D =50 A, V _{GS} =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	14	-	nC	V _{DD} =75 V, I _D =50 A, V _{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	10	15	nC	V _{DD} =75 V, I _D =50 A, V _{GS} =0 to 10 V
Switching charge	Q _{sw}	-	16	-	nC	V _{DD} =75 V, I _D =50 A, V _{GS} =0 to 10 V
Gate charge total ¹⁾	Qg	-	48	60	nC	V _{DD} =75 V, I _D =50 A, V _{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.6	-	V	V _{DD} =75 V, I _D =50 A, V _{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	41	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	136	181	nC	V _{DS} =75 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

Final Data Sheet 4 Rev. 2.0, 2023-08-17

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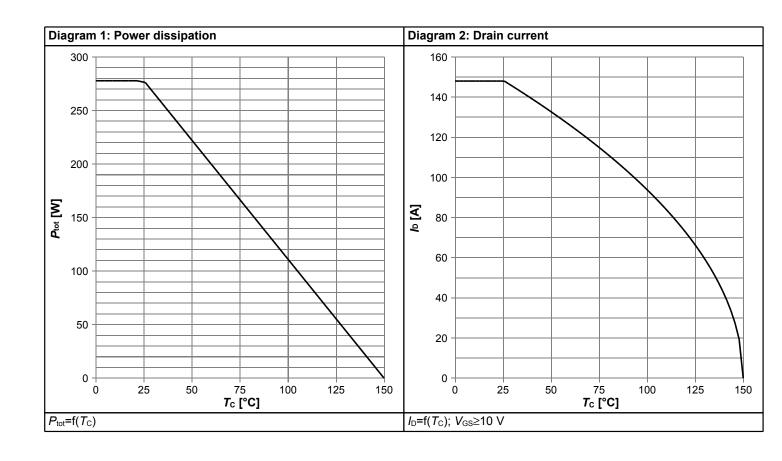


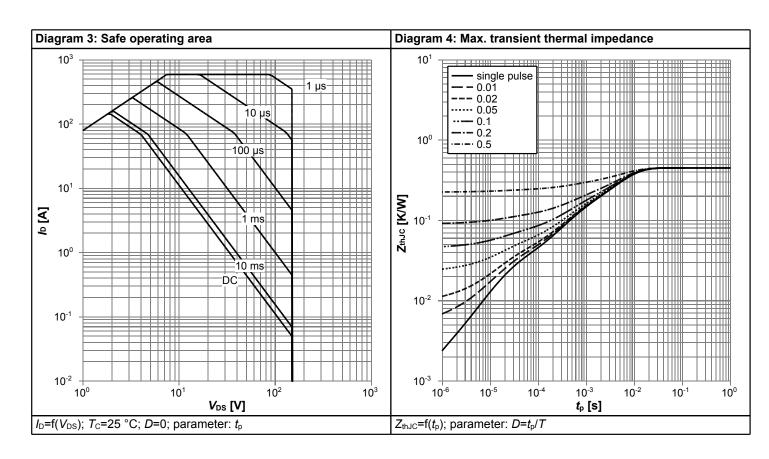
Table 7 Reverse diode

Poromotor	Complete	Values			11	Nata / Tant Can dition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	148	Α	<i>T</i> _C =25 °C	
Diode pulse current	I _{S,pulse}	-	-	592	Α	<i>T</i> _C =25 °C	
Diode forward voltage	V _{SD}	-	0.83	1.0	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C	
Reverse recovery time ¹⁾	t _{rr}	-	49	98	ns	V _R =75 V, I _F =25 A, di _F /dt=100 A/μs	
Reverse recovery charge ¹⁾	Qrr	-	55	110	nC	V _R =75 V, I _F =25 A, d <i>i</i> _F /d <i>t</i> =100 A/μs	
Reverse recovery time ¹⁾	t _{rr}	-	26	52	ns	V _R =75 V, I _F =50 A, di _F /dt=1000 A/μs	
Reverse recovery charge ¹⁾	Q _{rr}	-	195	390	nC	V_R =75 V, I_F =50 A, di_F/dt =1000 A/ μ s	

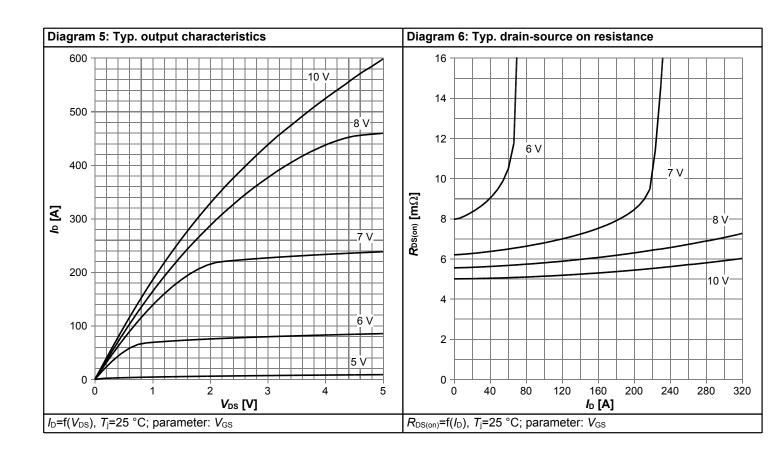


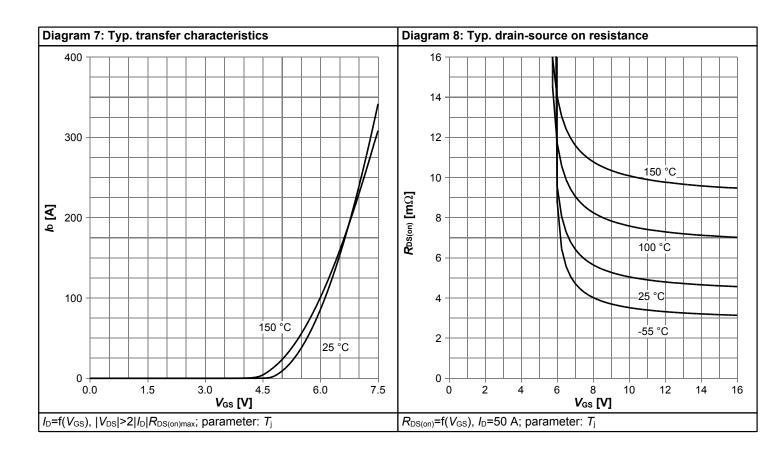
4 Electrical characteristics diagrams



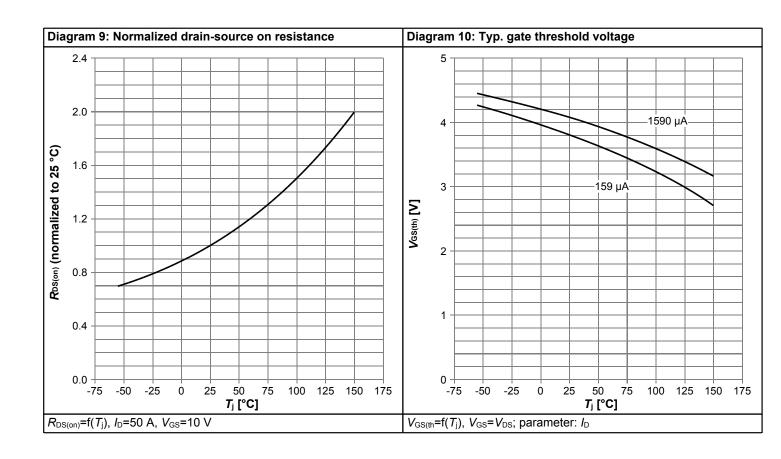


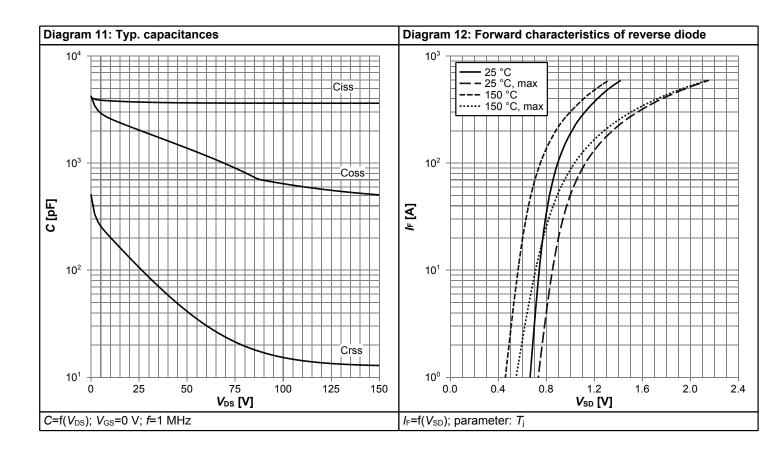




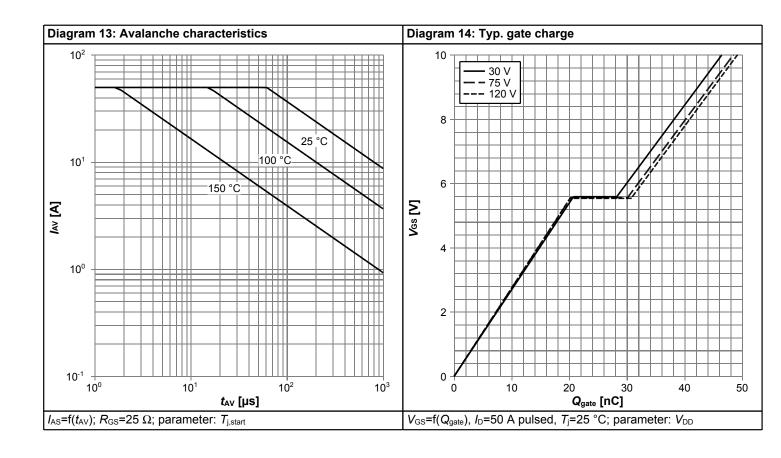


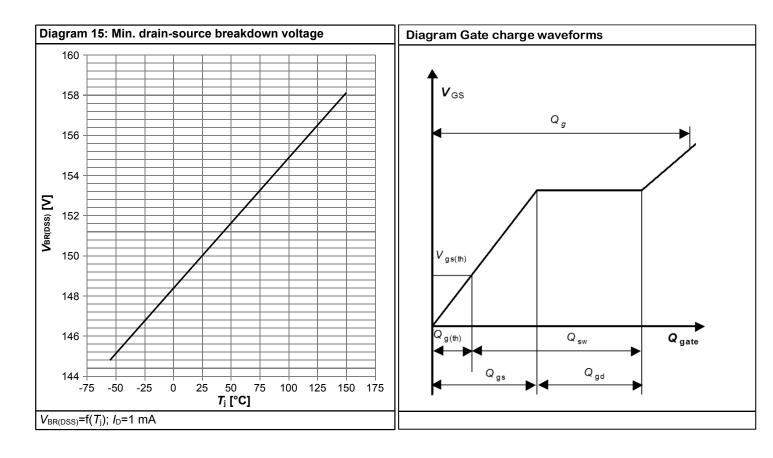














5 Package Outlines

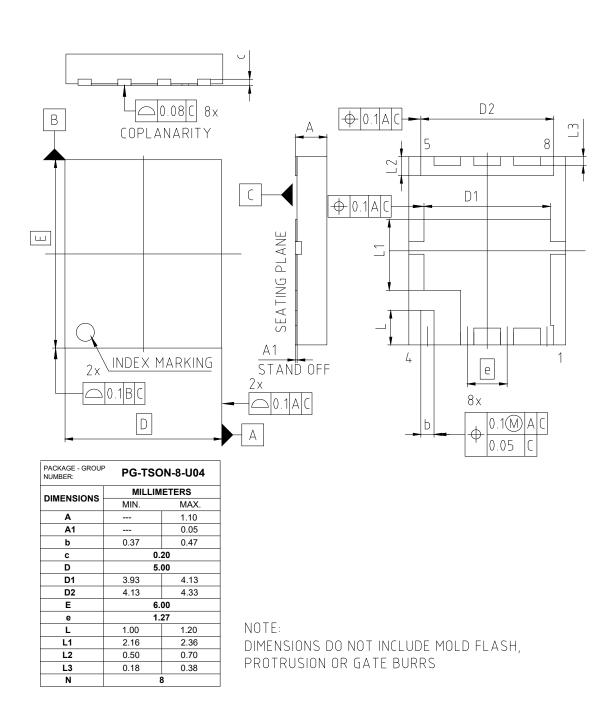


Figure 1 Outline PG-TSON-8, dimensions in mm

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Revision History

IQD063N15NM5

Revision: 2023-08-17, Rev. 2.0

Previous Revision

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Revision	Date	Subjects (major changes since last revision)				
2.0	2023-08-17	Release of final version				

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